DATA SHEET

# MOS FIELD EFFECT TRANSISTOR

# <sup>/</sup>NP48N055CHE, NP48N055DHE, NP48N055EHE

# SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

### DESCRIPTION

These products are N-channel MOS Field Effect Transistor designed for high current switching applications.

### FEATURES

- Channel temperature 175 degree rated
- Super low on-state resistance  $R_{DS(on)} = 17 \text{ m}\Omega \text{ MAX.} (V_{GS} = 10 \text{ V}, \text{ ID} = 24 \text{ A})$
- Low Ciss : Ciss = 1600 pF TYP.
- Built-in gate protection diode

#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

	Drain to Source Voltage	VDSS	55	V
	Gate to Source Voltage	Vgss	<u>±</u> 20	V
	Drain Current (DC)	D(DC)	<u>±</u> 48	А
r	Drain Current (Pulse) Note1	D(pulse)	±140	А
	Total Power Dissipation (TA = 25°C)	Рт	1.8	W
	Total Power Dissipation (Tc = 25°C)	Р⊤	85	W
	Single Avalanche Current Note2	AS	48 / 28 / 10	А
	Single Avalanche Energy Note2	Eas	2.3 / 78 / 100	mJ
	Channel Temperature	Tch	175	°C
	Storage Temperature	Tstg	-55 to +175	°C
	<b>Notes 1.</b> PW $\leq$ 10 $\mu$ s, Duty cycle $\leq$ 1 %			
		N /		

2. Starting T\_ch = 25 °C, R\_G = 25  $\Omega$  , V\_Gs = 20 V  ${\rightarrow}0$  V (see Figure 4.)

#### THERMAL RESISTANCE

Channel to Case	Rth(ch-C)	1.76	°C/W
Channel to Ambient	Rth(ch-A)	83.3	°C/W

#### **ORDERING INFORMATION**

PART NUMBER	PACKAGE		
NP48N055CHE	TO-220AB		
NP48N055DHE	TO-262		
NP48N055EHE	TO-263		



(TO-220AB)

(TO-262)



(TO-263)

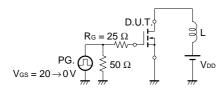


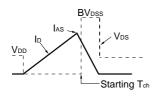
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# ★ ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C)

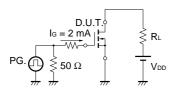
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)	Vgs = 10 V, Id = 24 A		14	17	mΩ
Gate to Source Threshold Voltage	VGS(th)	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	2.0	3	4.0	V
Forward Transfer Admittance	y₁s	Vds = 10 V, Id = 24 A	8	17		S
Drain Leakage Current	loss	Vds = 55 V, Vgs = 0 V			10	μA
Gate to Source Leakage Current	lgss	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±10	μA
Input Capacitance	Ciss	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz		1600	2400	pF
Output Capacitance	Coss			250	380	pF
Reverse Transfer Capacitance	Crss			120	220	pF
Turn-on Delay Time	td(on)	$I_{D} = 24 \text{ A}, \text{ V}_{GS(on)} = 10 \text{ V}, \text{ V}_{DD} = 28 \text{ V},$		22	48	ns
Rise Time	tr	R <sub>G</sub> = 1 Ω		16	40	ns
Turn-off Delay Time	$t_{d(off)}$			35	70	ns
Fall Time	tr			12	30	ns
Total Gate Charge	QG	$I_D = 48 \text{ A}, V_{DD} = 44 \text{ V}, \text{ Vgs} = 10 \text{ V}$		33	50	nC
Gate to Source Charge	Q <sub>GS</sub>			9		nC
Gate to Drain Charge	Qgd			12		nC
Body Diode Forward Voltage	VF(S-D)	IF = 48 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	I⊧ = 48 A, V₀s = 0 V, di/dt = 100 A/µs		40		ns
Reverse Recovery Charge	Qrr			55		nC

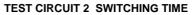
#### TEST CIRCUIT 1 AVALANCHE CAPABILITY

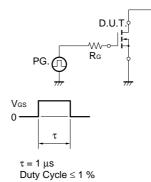


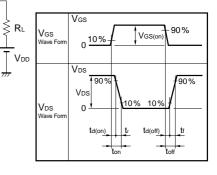


#### **TEST CIRCUIT 3 GATE CHARGE**

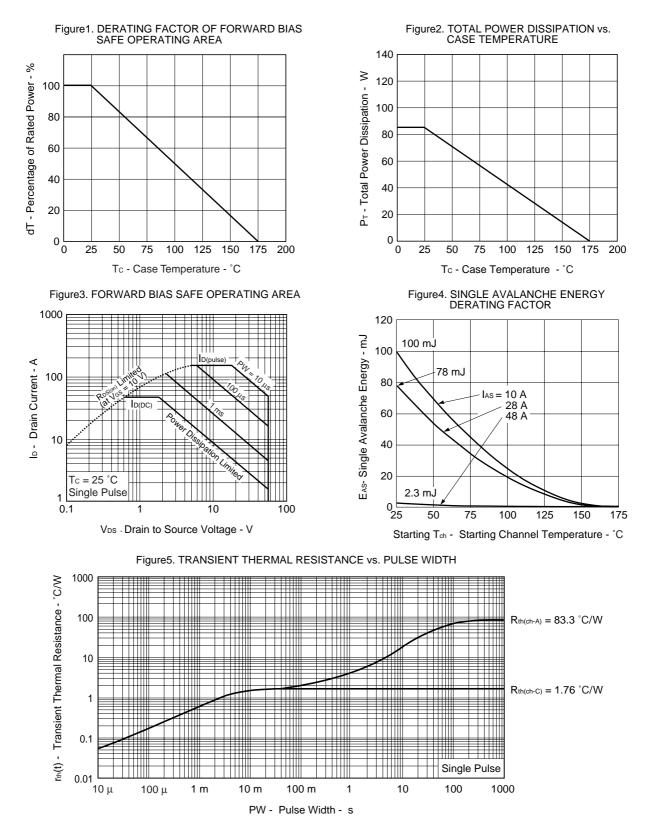








# **\*** TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25°C)



Data Sheet D14094EJ2V0DS00

Figure6. FORWARD TRANSFER CHARACTERISTICS

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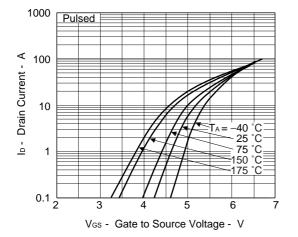
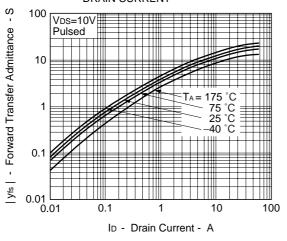
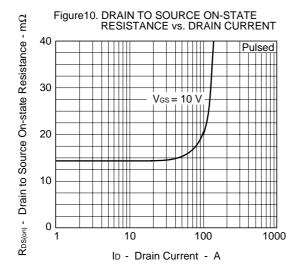
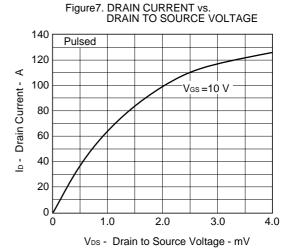




Figure8. FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT







C Figure9. DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

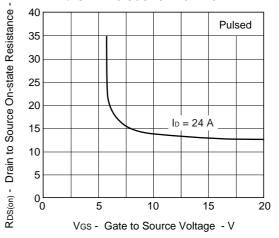
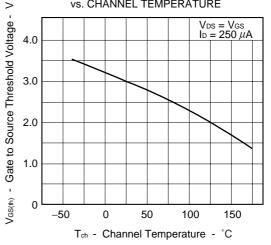


Figure 11. GATE TO SOURCE THRESHOLD VOLTAGE vs. CHANNEL TEMPERATURE



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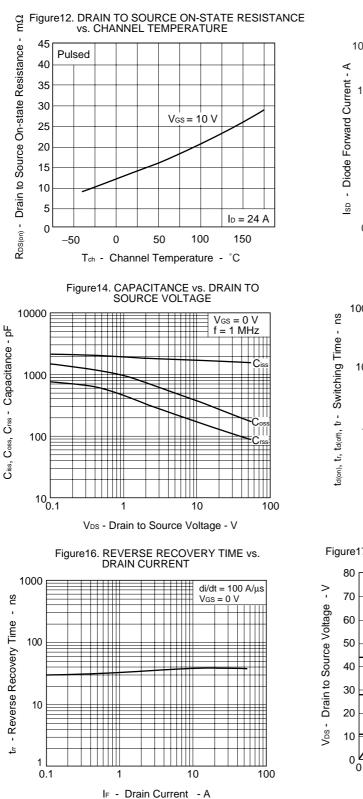


Figure 13. SOURCE TO DRAIN DIODE FORWARD VOLTAGE

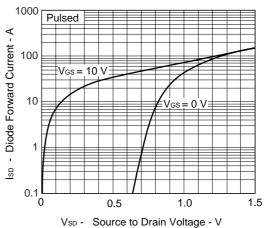
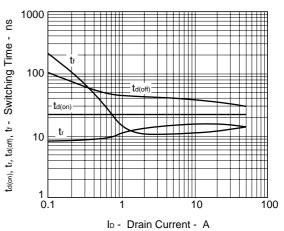
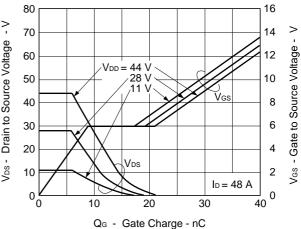


Figure15. SWITCHING CHARACTERISTICS



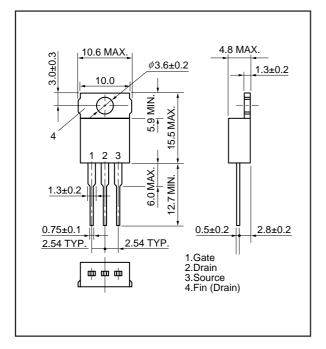




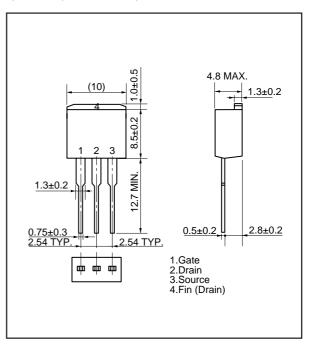
Data Sheet D14094EJ2V0DS00

## PACKAGE DRAWINGS (Unit: mm)

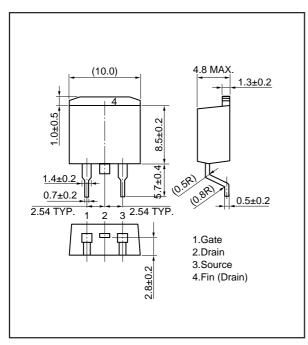
1) TO-220AB (MP-25)



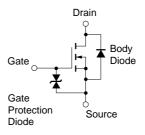
2) TO-262 (MP-25 Fin Cut)



3) TO-263 (MP-25ZJ)



EQUIVALENT CIRCUIT



**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

[MEMO]

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